

FIG. 1
(PRIOR ART)

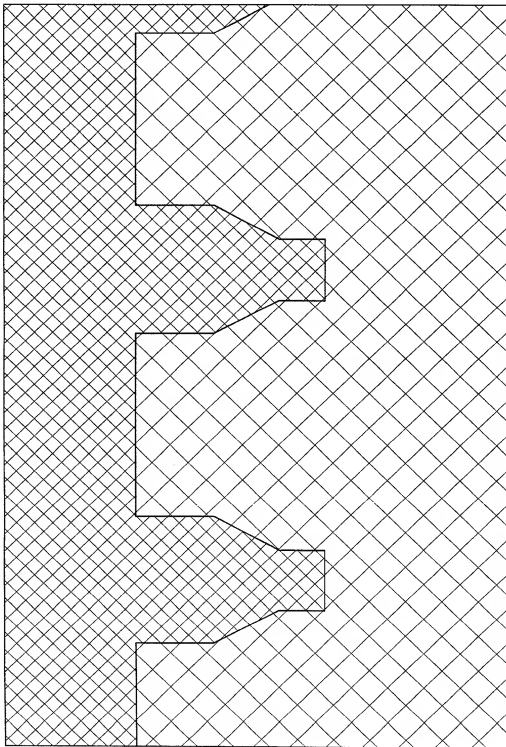


FIG.2
(PRIOR ART)

PROCESS: FLOWFILL AND H₂SO₄ CLIP AND 1000°C ANNEAL

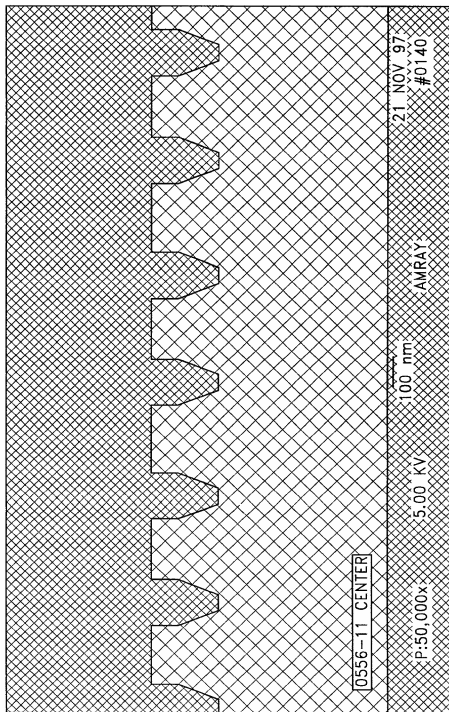


FIG.3

PROCESS: FLOWFILL AND H₂SO₄ CLIP AND 1000°C ANNEAL

ENLARGED PICTURE OF WAFER #11

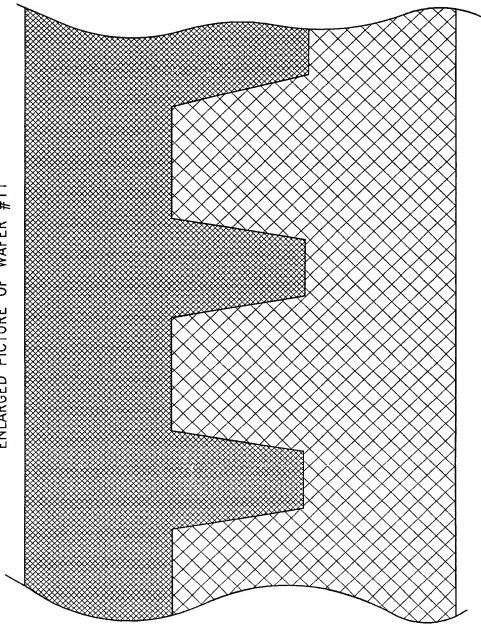


FIG.4

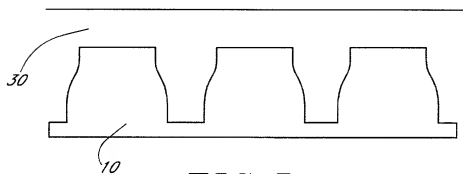


FIG. 5

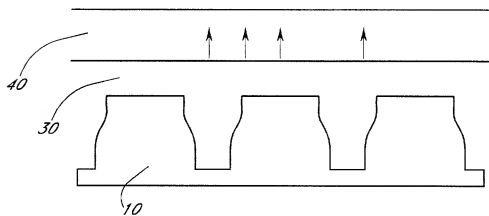


FIG. 6

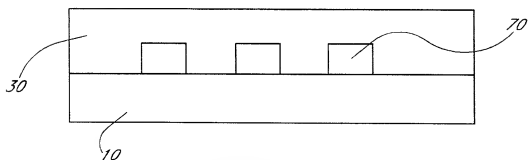


FIG. 7

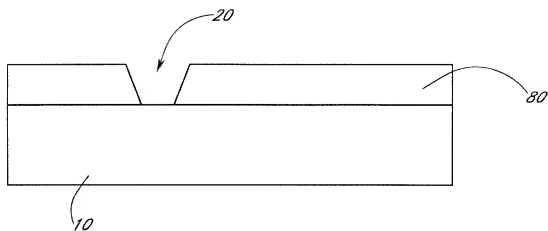


FIG. 8